

PATENT ASSIGNMENT

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SUBMISSION TYPE:	NEW ASSIGNMENT												
NATURE OF CONVEYANCE:	ASSIGNMENT												
CONVEYING PARTY DATA													
<table border="1"><thead><tr><th>Name</th><th>Execution Date</th></tr></thead><tbody><tr><td>SUNG MIN KIM</td><td>03/19/2008</td></tr><tr><td>CHANG JUN PARK</td><td>03/19/2008</td></tr><tr><td>KWON WHAN HAN</td><td>03/19/2008</td></tr><tr><td>SEONG CHEOL KIM</td><td>03/19/2008</td></tr><tr><td>HA NA LEE</td><td>03/19/2008</td></tr></tbody></table>	Name	Execution Date	SUNG MIN KIM	03/19/2008	CHANG JUN PARK	03/19/2008	KWON WHAN HAN	03/19/2008	SEONG CHEOL KIM	03/19/2008	HA NA LEE	03/19/2008	
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RECEIVING PARTY DATA													
Name:	HYNIX SEMICONDUCTOR INC.												
Street Address:	San 136-1, Ami-ri, Bubal-eub, Icheon-si												
City:	Kyongki-do												
State/Country:	KOREA, REPUBLIC OF												
PROPERTY NUMBERS Total: 1													
<table border="1"><thead><tr><th>Property Type</th><th>Number</th></tr></thead><tbody><tr><td>Application Number:</td><td>12059308</td></tr></tbody></table>	Property Type	Number	Application Number:	12059308									
Property Type	Number												
Application Number:	12059308												
CORRESPONDENCE DATA													
Fax Number:	(312)427-6663												
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NAME OF SUBMITTER:	Woochoon W. Park												
Total Attachments: 2 source=cu6444assign#page1.tif													

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PATENT
REEL: 020728 FRAME: 0709

UNITED STATES OF AMERICA
ASSIGNMENT

In consideration of the payment of ASSIGNEE to ASSIGNOR of the sum of One Dollar (\$1.00), the receipt of which is hereby acknowledged, and for the other good and valuable consideration,

ASSIGNOR:

Name : Sung Min KIM

Address : 212, Jungmyeong Honeyvill, 965, Dogok 1-dong, Gangnam-gu, Seoul, Korea

Name : Chang Jun PARK

Address : 603-402, Hyundai 6 cha Apt., Sadong-ri, Daewol-myeon, Icheon-si, Kyeonggi-do, Korea

Name : Kwon Whan HAN

Address : Ga-dong 206, 207-14, Junghwa 2-dong, Jungnang-gu, Seoul, Korea

Name : Seong Cheol KIM

Address : 636-6, Seok-dong, Jinhae-si, Gyeongsangnam-do, Korea

Name : Ha Na LEE

Address : 518-1101, Samsung 5 cha Apt., Jinsan-maeul, Pungdeokcheon 2-dong, Suji-gu, Yongin-si, Gyeonggi-do, Korea

(INVENTOR NAME AND ADDRESS)

hereby sells, assigns and transfers to

ASSIGNEE:

Name : Hynix Semiconductor Inc.

Address : San 136-1, Ami-ri, Bubal-eub, Icheon-si, Kyoungki-do, Korea

(ASSIGNEE NAME AND ADDRESS)

and the successors, assigns and legal representatives of the ASSIGNEE the entire right, title and interest for the United States and its territorial possessions in and to, any and all improvements which are disclosed in the invention entitled:
SEMICONDUCTOR CHIP WITH CHIP SELECTION STRUCTURE AND STACKED SEMICONDUCTOR PACKAGE HAVING THE SAME

(TITLE)

and which is found in *(check one applicable item below)*

☒ U.S. patent application executed on even date herewith

☐ U.S. Application Serial No. _____ filed on _____

and, in and to all Letters Patent to be obtained for said invention by the above application or any continuation, division, renewal, substitute, reissue or re-examination thereof.

ASSIGNOR hereby covenants that no assignment, sale agreement or encumbrance has been or will be made or entered into which would conflict with this assignment and sale;

ASSIGNOR further covenants that ASSIGNEE will, upon its request, be provided promptly with all pertinent facts and documents relating to said invention and said Letters Patent and legal equivalents as may be known and accessible to ASSIGNOR and will testify as to the same in any interference or litigation related thereto and will promptly execute and deliver to ASSIGNEE or its legal representatives any and all papers, instruments or affidavits required to apply for, obtain, maintain, issue and enforce said application, said invention and said Letters Patent and said equivalents thereof which may be necessary or desirable to carry out the purposes thereof.

IN WITNESS WHEREOF, I/we have set our hand and seal

March 19, 2008

Date

Sung min Kim

INVENTOR: Sung Min KIM

March 19, 2008

Date

Chang Jun PARK

INVENTOR: Chang Jun PARK

March 19, 2008

Date

Kwon Whan HAN

INVENTOR: Kwon Whan HAN

March 19, 2008

Date

Seong Cheol Kim

INVENTOR: Seong Cheol KIM

March 19, 2008

Date

Ha Na Lee

INVENTOR: Ha Na LEE

0699P/1

PATENT

RECORDED: 03/31/2008

REEL: 020728 FRAME: 0712